

**4-PIN ULTRA SMALL FLAT-LEAD,
LOW $C \times R$ $3\text{pF} \cdot \Omega$, 1-ch Optical Coupled MOS FET****DESCRIPTION**

The PS7801J-1A is a low output capacitance solid state relay containing a GaAs LED on the light emitting side (input side) and MOS FETs on the output side.

An ultra small flat-lead package has been provided which realizes a reduction in mounting area of about 50% compared with the PS72xx series.

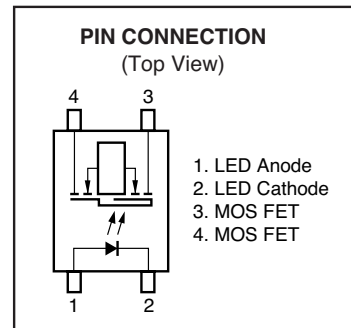
It is suitable for high-frequency signal control, due to its low $C \times R$ $3\text{pF} \cdot \Omega$, low output capacitance, and low off-state leakage current.

FEATURES

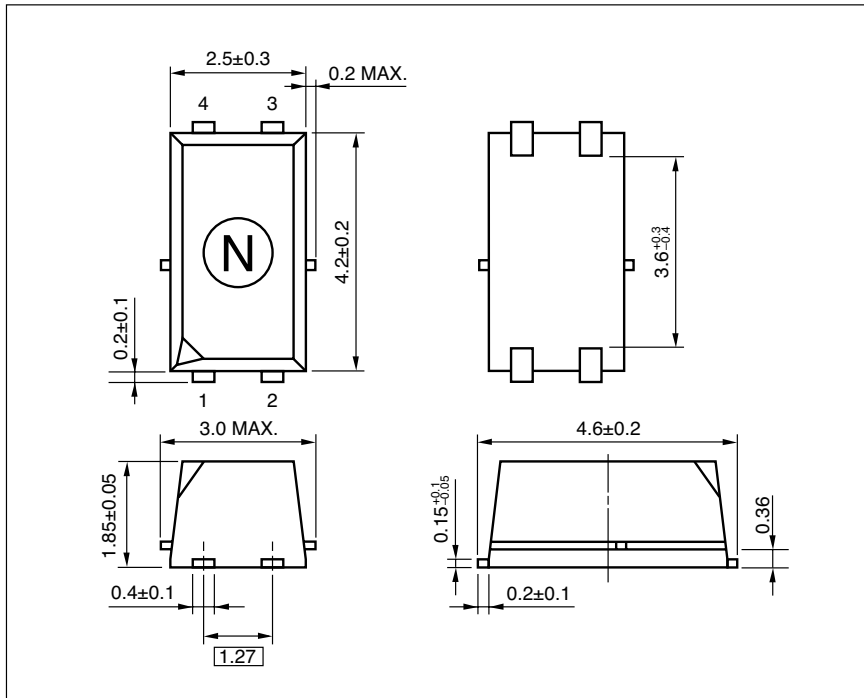
- Ultra small flat-lead package (4.2 (L) $\times$ 2.5 (W) $\times$ 1.85 (H) mm)
- Low $C \times R$ ($C \times R = 2.9 \text{ pF} \cdot \Omega$)
- Low output capacitance ($C_{\text{out}} = 1.3 \text{ pF TYP.}$)
- 1 channel type (1 a output)
- Designed for AC/DC switching line changer
- Low offset voltage
- Ordering number of taping product: PS7801J-1A-F3, F4 (3 500 pcs/reel)
- Pb-Free product
- UL awaiting approval

APPLICATIONS

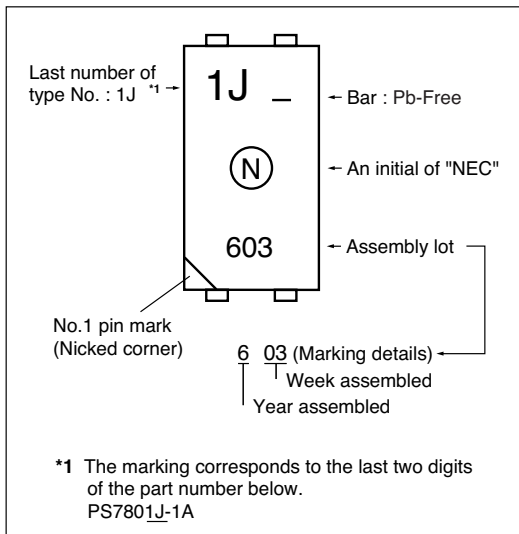
- Measurement equipment



PACKAGE DIMENSIONS (UNIT: mm)



MARKING EXAMPLE



ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number ^{*1}
PS7801J-1A-F3	PS7801J-1A-F3-A	Pb-Free	Embossed Tape 3 500 pcs/reel	UL awaiting approval	PS7801J-1A
PS7801J-1A-F4	PS7801J-1A-F4-A				

*1 For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$, unless otherwise specified)

	Parameter	Symbol	Ratings	Unit
Diode	Forward Current (DC)	I_F	50	mA
	Reverse Voltage	V_R	5.0	V
	Power Dissipation	P_D	50	mW
	Peak Forward Current ^{*1}	I_{FP}	1	A
MOS FET	Break Down Voltage	V_L	20	V
	Continuous Load Current	I_L	160	mA
	Pulse Load Current ^{*2} (AC/DC Connection)	I_{LP}	240	mA
	Power Dissipation	P_D	250	mW
Isolation Voltage ^{*2}		BV	500	Vr.m.s.
Total Power Dissipation		P_T	300	mW
Operating Ambient Temperature		T_A	-40 to +85	$^\circ\text{C}$
Storage Temperature		T_{stg}	-40 to +100	$^\circ\text{C}$

*1 $PW = 100 \mu\text{s}$, Duty Cycle = 1%

*2 $PW = 100 \text{ ms}$, 1 shot

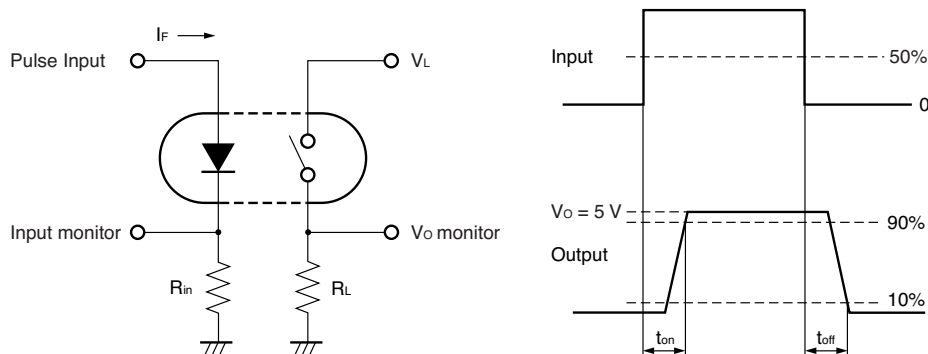
*3 AC voltage for 1 minute at $T_A = 25^\circ\text{C}$, RH = 60% between input and output
Pins 1-2 shorted together, 3-4 shorted together.

RECOMMENDED OPERATING CONDITIONS ($T_A = 25^\circ\text{C}$)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
LED Operating Current	I_F	2	5	20	mA
LED Off Voltage	V_F	0		0.5	V

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$)

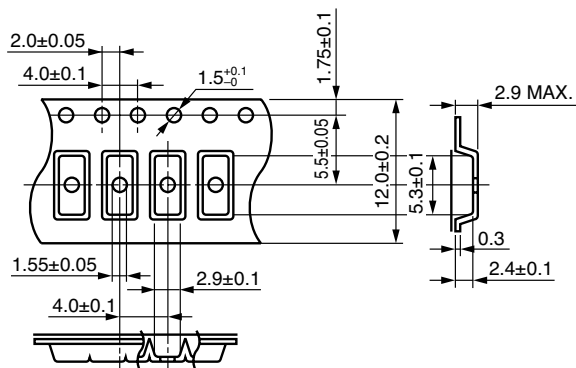
	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	V_F	$I_F = 5\text{ mA}$		1.1	1.4	V
	Reverse Current	I_R	$V_R = 5\text{ V}$			5.0	μA
MOS FET	Off-state Leakage Current	I_{Loff}	$V_D = 20\text{ V}$		0.01	0.25	nA
	Output Capacitance	C_{out}	$V_D = 0\text{ V}$, $f = 1\text{ MHz}$, $t < 1\text{ s}$		1.3	1.7	pF
Coupled	LED On-state Current	I_{Fon}	$I_L = 160\text{ mA}$			2.0	mA
	On-state Resistance	R_{on}	$I_F = 5\text{ mA}$, $I_L = 160\text{ mA}$, $t \leq 10\text{ ms}$		2.2	3.2	Ω
	Turn-on Time ^{*1,2}	t_{on}	$I_F = 5\text{ mA}$, $V_L = 5\text{ V}$, $R_L = 500\ \Omega$, $PW \geq 10\text{ ms}$		0.05	0.5	ms
	Turn-off Time ^{*1,2}	t_{off}			0.03	0.5	
	Isolation Resistance	$R_{\text{I-O}}$	$V_{\text{I-O}} = 0.5\text{ kV}_{\text{DC}}$	10^9			Ω
	Isolation Capacitance	$C_{\text{I-O}}$	$V = 0\text{ V}$, $f = 1\text{ MHz}$		0.3		pF

1 Test Circuit for Switching Time**2 The turn-on time and turn-off time are specified as input-pulse width $\geq 10\text{ ms}$.**

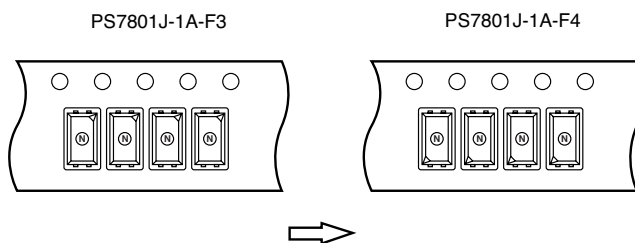
Be aware that when the device operates with an input-pulse width less than 10 ms, the turn-on time and turn-off time will increase.

TAPING SPECIFICATIONS (UNIT: mm)

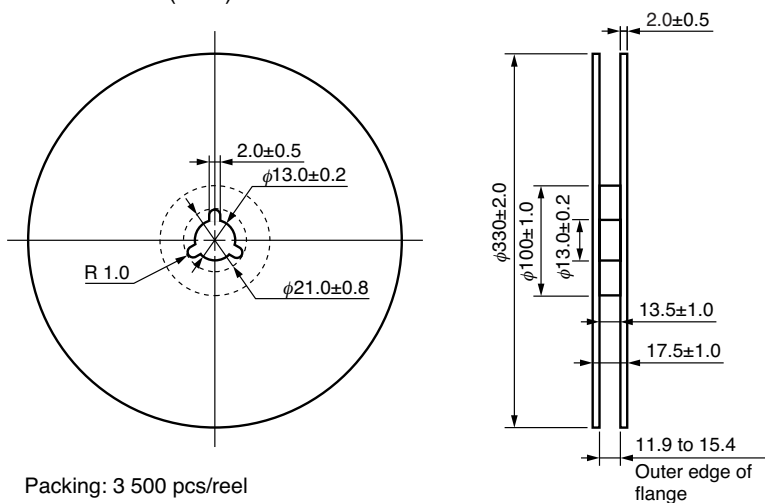
Outline and Dimensions (Tape)



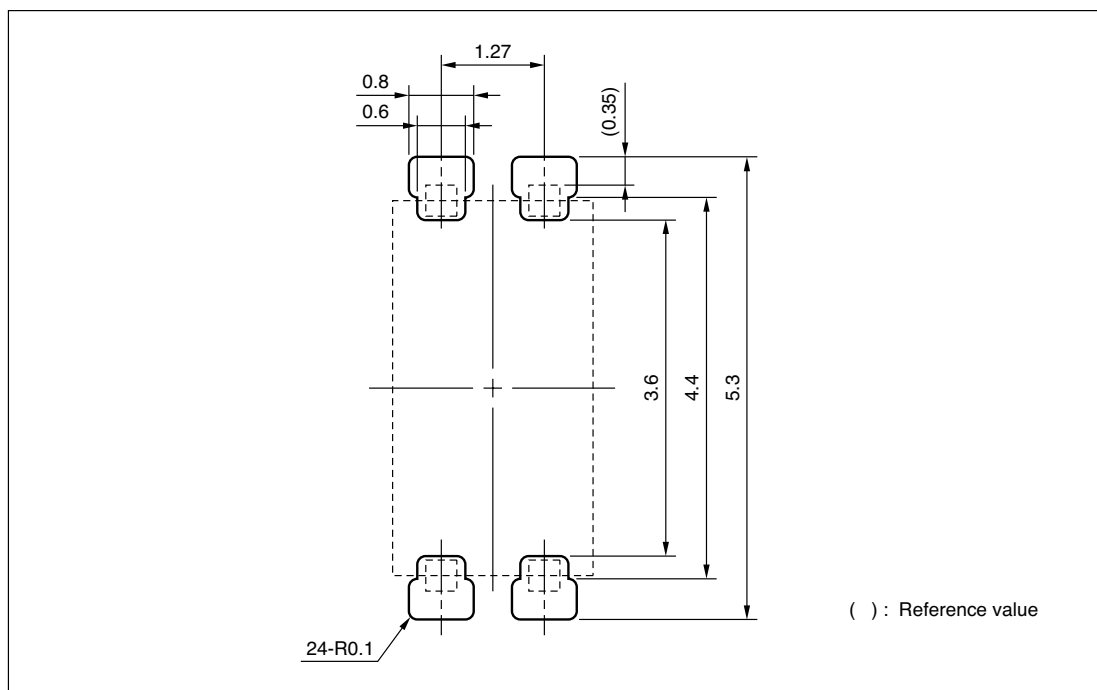
Tape Direction



Outline and Dimensions (Reel)



RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)

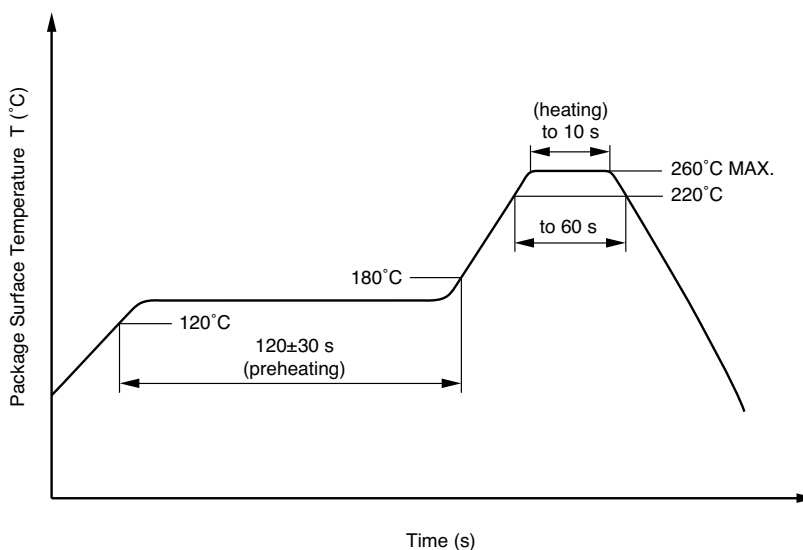


Remark All dimensions in this figure must be evaluated before use.

RECOMMENDED SOLDERING CONDITIONS**(1) Infrared reflow soldering**

- Peak reflow temperature 260°C or below (package surface temperature)
- Time of peak reflow temperature 10 seconds or less
- Time of temperature higher than 220°C 60 seconds or less
- Time to preheat temperature from 120 to 180°C 120±30 s
- Number of reflows Three
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow

**(2) Wave soldering**

- Temperature 260°C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times One
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(3) Cautions

- Fluxes
Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

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M8E 00.4-0110

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► For further information, please contact

NEC Compound Semiconductor Devices, Ltd. <http://www.ncsd.necel.com/>

E-mail: salesinfo@ml.ncsd.necel.com (sales and general)

techinfo@ml.ncsd.necel.com (technical)

Sales Division TEL: +81-44-435-1588 FAX: +81-44-435-1579

NEC Compound Semiconductor Devices Hong Kong Limited

E-mail: ncsd-hk@elhk.nec.com.hk (sales, technical and general)

Hong Kong Head Office TEL: +852-3107-7303 FAX: +852-3107-7309

Taipei Branch Office TEL: +886-2-8712-0478 FAX: +886-2-2545-3859

Korea Branch Office TEL: +82-2-558-2120 FAX: +82-2-558-5209

NEC Electronics (Europe) GmbH <http://www.ee.nec.de/>

TEL: +49-211-6503-0 FAX: +49-211-6503-1327

California Eastern Laboratories, Inc. <http://www.cel.com/>

TEL: +1-408-988-3500 FAX: +1-408-988-0279

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CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The –AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)	Concentration contained in CEL devices	
		-A	-AZ
Lead (Pb)	< 1000 PPM	Not Detected	(*)
Mercury	< 1000 PPM	Not Detected	
Cadmium	< 100 PPM	Not Detected	
Hexavalent Chromium	< 1000 PPM	Not Detected	
PBB	< 1000 PPM	Not Detected	
PBDE	< 1000 PPM	Not Detected	

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